

MOS FIELD EFFECT TRANSISTOR **2SK2415, 2SK2415-Z**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

NEC

The 2SK2415 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

Low On-Resistance

 $\begin{aligned} &\mathsf{R}_{\mathsf{DS}(\mathsf{on})1} = 0.10 \ \Omega \ \mathsf{MAX}. \ (@ \ \mathsf{VGS} = 10 \ \mathsf{V}, \ \mathsf{ID} = 4.0 \ \mathsf{A}) \\ &\mathsf{R}_{\mathsf{DS}(\mathsf{on})2} = 0.15 \ \Omega \ \mathsf{MAX}. \ (@ \ \mathsf{VGS} = 4 \ \mathsf{V}, \ \mathsf{ID} = 4.0 \ \mathsf{A}) \end{aligned}$

• Low Ciss Ciss = 570 pF TYP.

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 $^{\circ}$ C)

Drain to Source Voltage	Vdss	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	D(DC)	±8.0	А
Drain Current (pulse)*	D(pulse)	±32	А
Total Power Dissipation (Tc = 25 °C)	Pt1	20	W
Total Power Dissipation (Ta = 25 °C)	Pt2	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current**	las	8.0	А
Single Avalanche Energy**	Eas	6.4	mJ

* PW \leq 10 μ s, Duty Cycle \leq 1 %

** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



The information in this document is subject to change without notice.

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	RDS(on)1		0.07	0.10	Ω	Vgs = 10 V, Id = 4.0 A
Drain to Source On-State Resistance	RDS(on)2		0.10	0.15	Ω	Vgs = 4 V, Id = 4.0 A
Gate to Source Cutoff Voltage	VGS(off)	1.0	1.6	2.0	V	$V_{DS} = 10 V, I_{D} = 1 mA$
Forward Transfer Admittance	y _{fs}	5.0	8.4		S	V _{DS} = 10 V, I _D = 4.0 A
Drain Leakage Current	IDSS			10	μΑ	$V_{DS} = 60 V, V_{GS} = 0$
Gate to Source Leakage Current	lgss			±10	μΑ	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		570		pF	V _{DS} = 10 V
Output Capacitance	Coss		290		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		75		pF	f = 1 MHz
Turn-On Delay Time	td(on)		5		ns	ID = 4.0 A
Rise Time	tr		60		ns	$V_{GS(on)} = 10 V$
Turn-Off Delay Time	td(off)		75		ns	Vdd = 30 V
Fall Time	tr		40		ns	R _G = 10 Ω
Total Gate Charge	QG		21		nC	ID = 8.0 A
Gate to Source Charge	QGS		2.0		nC	VDD = 48 V
Gate to Drain Charge	Qgd		6.5		nC	Vgs = 10 V
Body Diode Forward Voltage	VF(S-D)		1.0		V	IF = 8.0 A, VGS = 0
Reverse Recovery Time	trr		85		ns	IF = 8.0 A, VGS = 0
Reverse Recovery Charge	Qrr		200		nC	di/dt = 100 A/µs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time







Test Circuit 3 Gate Charge



The application circuits and their parameters are for references only and are not intended for use in actual design-in's.







FORWARD BIAS SAFE OPERATING AREA



DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE















GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



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SWITCHING CHARACTERISTICS





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REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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Anti-radioactive design is not implemented in this product.